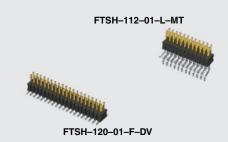


FTSH





(1.27 mm) .050"

MT MICRO HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FTSH

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze

Plating: Sn or Au over 50 μ" (1.27 μm) Ni Current Rating (FTSH/CLP): 3.4 A per pin (2 pins powered)

Operating Temp Range: -55 °C to +125 °C RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity:

-MT & -DV Tail Option: (0.10 mm) .004" max (02-25) -MT & -DH Tail Option: (0.15 mm) .006" max (26-50)*
*(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



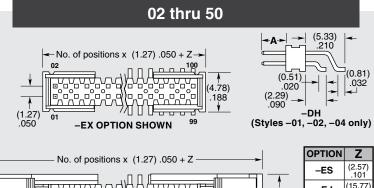
ALSO AVAILABLE (MOQ Required)

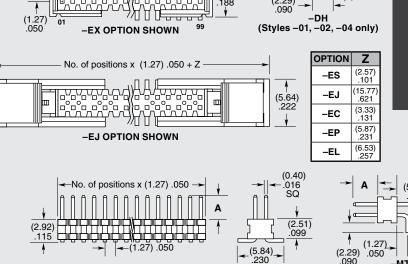
- · Molded Pick & Place pads
- Latches
- Other platings

Board Mates: APPLICATIONS OTHER SOLUTIONS **Cable Mates:** CLP FTSH FFSD, FFT **OPTIONS** HORIZONTAL -ES OPTION -EC OPTION Ultra-low profile option available. End Shrouds available. Call for FTS Series specifications. -EP OPTION HIGH-SPEED CHANNEL PERFORMANCE Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com -EJ OPTION -EL OPTION -TR OPTION

NO. PINS

PER ROW





-01 = (3.05 mm) .120" Post (Mates with FFSD) **-02** = (1.91 mm) .075" Post (Mates with FLE) -03 = (1.65 mm) .065" Post (Mates with CLP-D) = (3.81 mm) .150" Post (Mates with CLP-DH) -05 = (4.32 mm) .170" Post (Mates with CLP-BE) LEAD STYLE 3.05 -01 .120 (1.91) -02 (5.08) .200 -03 .065 (3.81)-04 -05

(0.81)

.050

-MT

(Styles -01, -02 & -04 only)

LEAD

Some sizes, styles and options are non-standard, non-returnable.

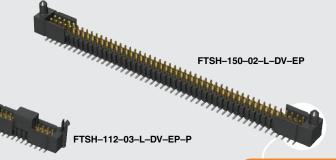
See SFM/TFM for positive alignment feature.

-DV

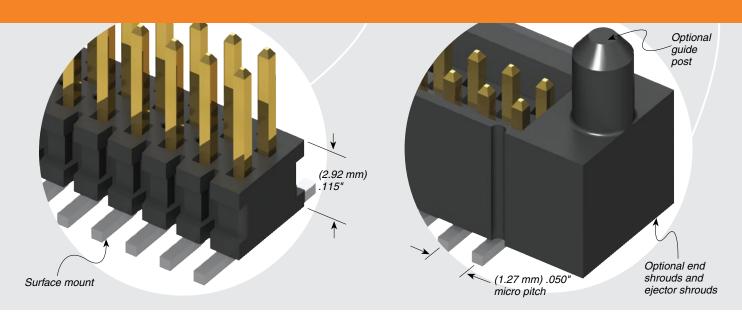


FTSH-110-04-F-DV





FTSH SERIES



PLATING TAIL FLEX SHROUD OPTION OPTION **OPTION OPTIONS** –F Leave Blank -DV (Style -02 & -03 only, -DH & -MT not available) for -DH & -MT 9 pins/row minimum (Other positions available. Call Samtec.) = Gold flash = Double on post, Vertical -"XXX" Matte Tin = Polarized on tail -DH -ES –EL Position = Double (Specify = End Shroud = End Shroud with Board Lock Horizontal position of (Boards are positively locked and cannot be unmated) (Styles -01, -02 & -04 only) = 10 µ" omitted pin) -EC (0.25 µm) Not available = End Shroud Gold on post with -EX –EJ with Locking Clip Matte Tin options) on tail (Manual placement = Ejector Shroud -MT(Style –01 only) –DH & –MT not available required) = Mixed Technology -EP 10 pins/row minimum (Styles 25 pins/row maximum -01, -02 **&** = End Shroud (1.91) -.075 with Guide Post -04 only) DIA (3.05) (4.83).190 (0.89) (0.86)-ES -EP .034 (1.17) .046 (3.30)(2.16) .085 .130 (5.08)x → (5.08) .200 (3.05) .120 .200 (11.18) .440 (3.20)(4.10) .126 .160 (1.22)(4.83)(2.29) .048 .190

-EJ

.090

-EL

113

-EC

OTHER OPTIONS

= Keying Shroud (For mating with FFSD Style –01 only and 05, 08, 10, 13, 15, 17, 20 & 25 pins/row only. 13, 17, 20 & 25 pins/row only with –EJ option) (–DV only)

-A

= Alignment Pin (-DV 3 positions min.) (-DH 5 positions min.) (Metal or plastic at Samtec discretion)

-C

= (5.00 mm) .197" DIA Polyimide film Pick & Place Pad (-DH only)

= Pick & Place Pad (-DV 4 positions min.) (-DH & -MT not available)

-TR

= Tape & Reel Packaging (Flex Shroud options not available except –ES & –EJ)

-FR

 Full Reel Tape & Reel Packaging (Must order maximum quantities per reel. Contact Samtec for parts per reel)

Due to technical progress, all designs, specifications and components are subject to change without notice

-K